Vishay Siliconix

# N-Channel 60 V (D-S) MOSFET

#### SOT-23 (TO-236)



Marking Code: Si2308BDS (L8)

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	60					
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10 \text{ V}$	0.156					
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 4.5 \text{ V}$	0.192					
Q <sub>g</sub> typ. (nC)	2.3					
I <sub>D</sub> (A) <sup>a</sup>	2.1					
Configuration	Single					

#### **FEATURES**

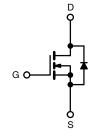
- Halogen-free according to IEC 61249-2-21 available
- TrenchFET® power MOSFET
- 100 % R<sub>g</sub> and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

# Pb-free RoHS

ROHS COMPLIANT HALOGEN FREE

#### **APPLICATIONS**

- Battery Switch
- DC/DC Converter



N-Channel MOSFET

ORDERING INFORMATION			
Package	TSOP-6 Single		
Lead (Pb)-free	SI2308BDS-T1-E3		
Lead (Pb)-free and halogen-free	SI2308BDS-T1-GE3		
	SI2308BDS-T1-BE3		

ABSOLUTE MAXIMUM RATINGS	$(1_A = 25)$ C, unless	otherwise no	itea)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		$V_{DS}$	60	٧	
Gate-source voltage		$V_{GS}$	±20	7 v	
	T <sub>C</sub> = 25 °C		2.3		
Continuous drain surrent (T. 150 °C)	T <sub>C</sub> = 70 °C	] ,	1.8		
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	1.9 b,c		
	T <sub>A</sub> = 70 °C		1.5 <sup>b,c</sup>		
Pulsed drain current	I <sub>DM</sub>	8	Α		
Continuous source-drain diode current	T <sub>C</sub> = 25 °C	I <sub>S</sub>	1.39	1	
	T <sub>A</sub> = 25 °C		0.91 <sup>b,c</sup>	1	
Avalanche current	l 0.1 mall	I <sub>AS</sub>	6	1	
Single pulse avalanche energy	L = 0.1 mH	E <sub>AS</sub>	1.8	1	
Maximum power dissipation	T <sub>C</sub> = 25 °C		1.66		
	T <sub>C</sub> = 70 °C		1.06	147	
	T <sub>A</sub> = 25 °C	$P_{D}$	1.09 <sup>b,c</sup>	W	
	T <sub>A</sub> = 70 °C		0.7 b,c		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stq</sub>	-55 to +150	°C	

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum Junction-to-Ambient b, d	t ≤ 5 s	$R_{thJA}$	90	115	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	$R_{thJF}$	60	75	G/W	

#### Notes

- a.  $T_C = 25 \,^{\circ}C$
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 5 s
- d. Maximum under steady state conditions is 130 °C/W



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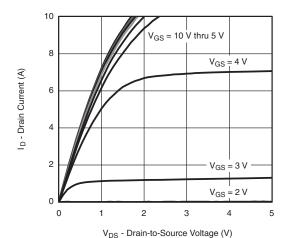
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{DS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	60	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	J 050A	-	55	-	mV/°C	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	-5	-		
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1	-	3	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA	
Zara gata valtaga duain avurant	_	V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V	-	-	1		
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C	-	-	10	- μΑ	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge -5 \text{ V}, V_{GS} = 10 \text{ V}$	8	-	-	Α	
Drain accuracy on atota vaciation as 3	В	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 1.9 A	-	0.130	0.156	Ω	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 1.7 A	-	0.160	0.192		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 1.9 A	-	5	-	S	
Dynamic <sup>b</sup>				•	•	,	
Input capacitance	C <sub>iss</sub>		-	190	-	pF	
Output capacitance	Coss	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	26	-		
Reverse transfer capacitance	C <sub>rss</sub>		-	15	-		
Total gate charge $Q_g = V_{DS} = 30^{\circ}$	0	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 1.9 A	-	4.5	6.8		
		-	2.3	3.5			
Gate-source charge	Q <sub>gs</sub>	$V_{DS} = 30 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 1.9 \text{ A}$	-	0.8	-	nC	
Gate-drain charge	$Q_{gd}$		-	1	-		
Gate resistance	$R_g$	f = 1 MHz	0.6	2.8	5.6	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	4	6		
Rise time	t <sub>r</sub>	$V_{DD}$ = 30 V, $R_L$ = 20 $\Omega$	-	10	15		
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong 1.5 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	10	15		
Fall time	t <sub>f</sub>		-	7	10.5	1	
Turn-on delay time	t <sub>d(on)</sub>		-	15	23	ns	
Rise time	t <sub>r</sub>	$V_{DD}$ = 30 V, $R_L$ = 20 $\Omega$	-	16	24		
Turn-off delay time	t <sub>d(off)</sub>	$I_D = 1.5 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$	-	11	17		
Fall time	t <sub>f</sub>		-	11	17		
Drain-Source Body Diode Characterist	ics						
Continuous source-drain diode current	IS	T <sub>C</sub> = 25 °C	-	-	1.39	^	
Pulse diode forward current <sup>a</sup>	I <sub>SM</sub>		-	-	8	A	
Body diode voltage	$V_{SD}$	I <sub>S</sub> = 1.5 A	-	0.8	1.2	V	
Body diode reverse recovery time	t <sub>rr</sub>		-	15	23	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	1 454 41/41 400 4/ 7 65 00	-	10	15	nC	
Reverse recovery fall time	ta	$I_F = 1.5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$	-	12	-		
Reverse recovery rise time	t <sub>b</sub>		-	3	_	ns	

#### Notes

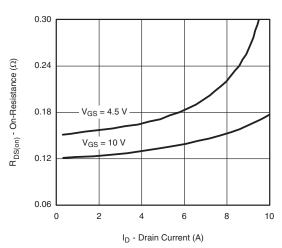
- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

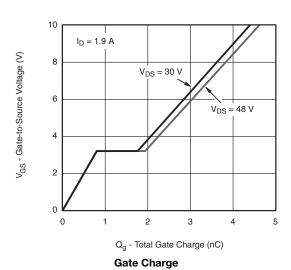


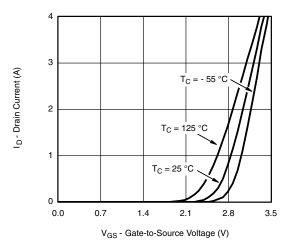


#### **Output Characteristics**

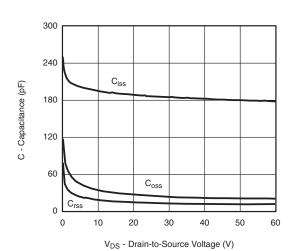


#### On-Resistance vs. Drain Current

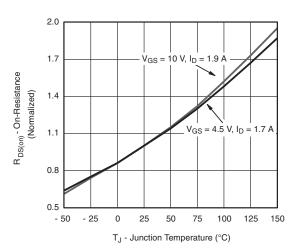




#### **Transfer Characteristics**

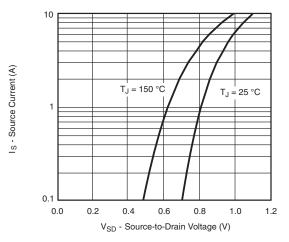


#### Capacitance

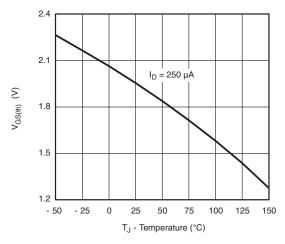


On-Resistance vs. Junction Temperature

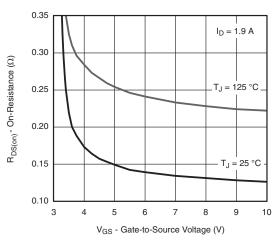




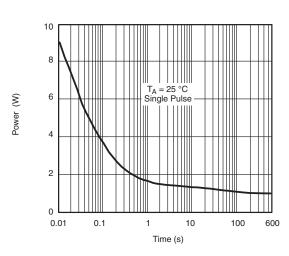
#### Source-Drain Diode Forward Voltage



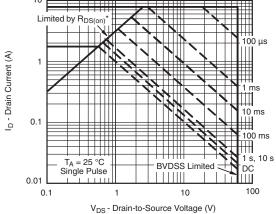
**Threshold Voltage** 



On-Resistance vs. Gate-to-Source Voltage



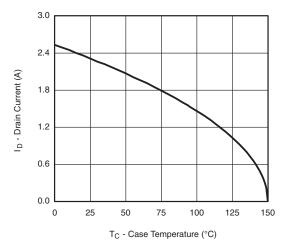
Single Pulse Power, Junction-to-Ambient



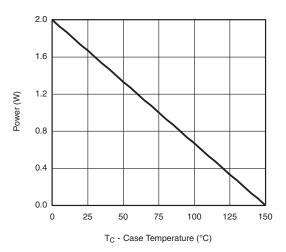
\* V<sub>GS</sub> > minimum V<sub>GS</sub> at which R<sub>DS(on)</sub> is specified

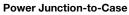
Safe Operating Area

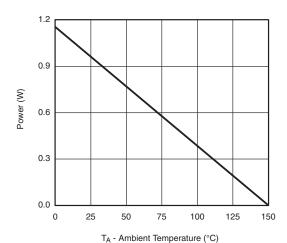




#### Current Derating a





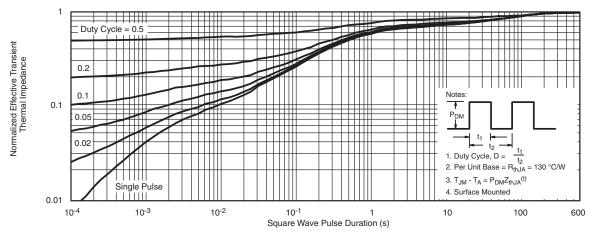


**Power Junction-to-Ambient** 

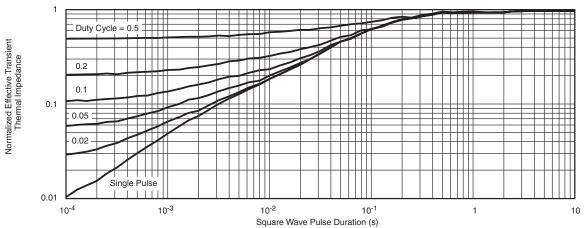
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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## SOT-23 (TO-236): 3-LEAD







Dim	MILLI	METERS	INCHES		
	Min	Max	Min	Max	
Α	0.89	1.12	0.035	0.044	
A <sub>1</sub>	0.01	0.10	0.0004	0.004	
A <sub>2</sub>	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
С	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E <sub>1</sub>	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e <sub>1</sub>	1.90 BSC		0.074	8 Ref	
L	0.40	0.60	0.016	0.024	
L <sub>1</sub>	0.64 Ref		0.025 Ref		
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	
FCN: S-03946-Rev K 09-	lul-01	•			

ECN: S-03946-Rev. K, 09-Jul-01

DWG: 5479

Document Number: 71196 www.vishay.com 09-Jul-01



#### **RECOMMENDED MINIMUM PADS FOR SOT-23**



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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